## SN74LVCC4245A OCTAL DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

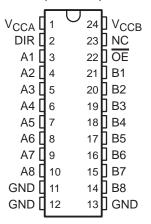
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- **Bidirectional Voltage Translator**
- 4.5 V to 5.5 V on A Port and 2.7 V to 5.5 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- **ESD Protection Exceeds JESD 22** 
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

### description/ordering information

This 8-bit (octal) noninverting bus transceiver uses two separate power-supply rails. The A port, V<sub>CCA</sub>, is dedicated to accept a 5-V supply level, and the configurable B port, which is designed to track V<sub>CCB</sub>, accepts voltages from 3 V to 5 V. This allows for translation from a 3.3-V to a 5-V environment and vice versa.

#### DB, DW, NS, OR PW PACKAGE (TOP VIEW)



NC - No internal connection

The SN74LVCC4245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so the buses are effectively isolated.

#### ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SOIC - DW	Tube of 25	SN74LVCC4245ADW	LVCC4245A
	30IC - DVV	Reel of 2000	SN74LVCC4245ADWR	LVCC4245A
–40°C to 85°C	SOP - NS	Reel of 2000	SN74LVCC4245ANSR	LVCC4245A
	SSOP – DB	Reel of 2000	SN74LVCC4245ADBR	LG245A
		Tube of 60	SN74LVCC4245APW	
	TSSOP - PW	Reel of 2000	SN74LVCC4245APWR	LG245A
		Reel of 250	SN74LVCC4245APWT	

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

#### **FUNCTION TABLE** (each transceiver)

INP	UTS	ODEDATION		
OE	DIR	OPERATION		
L	L	B data to A bus		
L	Н	A data to B bus		
Н	X	Isolation		

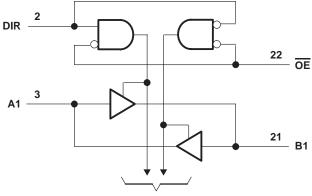


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### logic diagram (positive logic)



To Seven Other Channels

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CCA</sub> and V <sub>CCB</sub>	
Input voltage range, V <sub>I</sub> (see Note 1): I/O ports (A port)	
I/O ports (B port)	5 V to V <sub>CCB</sub> + 0.5 V
Except I/O ports0.4	
Output voltage range, V <sub>O</sub> (see Note 1): A port	5 V to $V_{CCA}$ + 0.5 V
B port −0.5	5 V to $V_{CCB}$ + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–50 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, IO	±50 mA
Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND	±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DB package	63°C/W
DW package	46°C/W
NS package	65°C/W
PW package	88°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



NOTES: 1. This value is limited to 6 V maximum.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 3)

			VCCA	VCCB	MIN	NOM	MAX	UNIT
VCCA	Supply voltage				4.5	5	5.5	V
VCCB	Supply voltage				2.7	3.3	5.5	V
			4.5.1/	2.7 V	2			
$V_{IHA}$	/IHA High-level input voltage	$V_{OB} \le 0.1 \text{ V or } V_{OB} \ge V_{CCB} - 0.1 \text{ V}$	4.5 V	3.6 V	2			V
			5.5 V	5.5 V	2			
		ve $V_{OA} \le 0.1 \text{ V or } V_{OA} \ge V_{CCA} - 0.1 \text{ V}$	4.5.\/	2.7 V	2			
$V_{IHB}$	High-level input voltage		4.5 V	3.6 V	2			V
			5.5 V	5.5 V	3.85			
			4.5.1/	2.7 V			0.8	
$V_{ILA}$	Low-level input voltage	vel input voltage $V_{OB} \le 0.1 \text{ V or } V_{OB} \ge V_{CCB} - 0.1 \text{ V}$ 4.5 V	3.6 V			0.8	V	
			5.5 V	5.5 V			0.8	
			4 = 14	2.7 V			0.8	
$V_{ILB}$	Low-level input voltage	input voltage $V_{OA} \le 0.1 \text{ V or } V_{OA} \ge V_{CCA} - 0.1 \text{ V}$ 4.5 V 5.5 V	4.5 V	3.6 V			0.8	V
			5.5 V	5.5 V			1.65	
		V < 0.4 V on V > V 0.4 V	4.5 V	3.6 V	2	-		
	High-level input voltage	$V_{OB} \le 0.1 \text{ V or } V_{OB} \ge V_{CCB} - 0.1 \text{ V}$	5.5 V	5.5 V	2			
$V_{IH}$	(control pins) High-level input voltage (control pins)  VOA ≤ 0.1 V or VOA ≥ VCCA − 0.1 V			2.7 V	2	-		V
		4.5 V	3.6 V	2				
	(		5.5 V	5.5 V	2	-		
			4.5.7	2.7 V		-	0.8	
	Lavo lavolinavit valtana	$V_{OB} \le 0.1 \text{ V or } V_{OB} \ge V_{CCB} - 0.1 \text{ V}$	4.5 V	3.6 V			0.8	
	Low-level input voltage (control pins)		5.5 V	5.5 V		:	0.8	.,
$V_{IL}$	Low-level input voltage			2.7 V			0.8	V
	(control pins)	$V_{OA} \le 0.1 \text{ V or } V_{OA} \ge V_{CCA} - 0.1 \text{ V}$	4.5 V	3.6 V			0.8	
			5.5 V	5.5 V		-	0.8	
VIA	Input voltage	•			0	-	VCCA	V
VIB	Input voltage				0	-	VCCB	V
VOA	Output voltage				0	-	VCCA	V
V <sub>OB</sub>					0	-	V <sub>CCB</sub>	V
IOHA	High-level output current		4.5 V	3 V			-24	mA
ІОНВ			4.5 V	2.7 V to 4.5 V			-24	mA
IOLA	Low-level output current		4.5 V	3 V		-	24	mA
IOLB	Low-level output current		4.5 V	2.7 V to 4.5 V			24	mA
TA	Operating free-air tempera	ature			-40		85	°C

NOTE 3: All unused inputs of the device must be held at the associated V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PAI	RAMETER	TEST CONDITIONS	VCCA	VCCB	MIN	TYP	MAX	UNIT	
V		I <sub>OH</sub> = -100 μA	4.5 V	3 V	4.4	4.49		V	
VOHA		I <sub>OH</sub> = -24 mA	4.5 V	3 V	3.76	4.25		V	
		$I_{OH} = -100 \mu\text{A}$	4.5 V	3 V	2.9	2.99			
		I <sub>OH</sub> = -12 mA	4.5 V	2.7 V	2.2	2.5			
Vонв		IOH = -12 IIIA	4.5 V	3 V	2.46	2.85		٧	
√OHB				2.7 V	2.1	2.3		V	
		$I_{OH} = -24 \text{ mA}$	4.5 V	3 V	2.25	2.65			
				4.5 V	3.76	4.25			
\/a  1		I <sub>OL</sub> = 100 μA	4.5 V	3 V			0.1	V	
VOLA		$I_{OL} = 24 \text{ mA}$	4.5 V	3 V		0.21	0.44	V	
		I <sub>OL</sub> = 100 μA	4.5 V	3 V			0.1		
		I <sub>OL</sub> = 12 mA	4.5 V	2.7 V		0.11	0.44		
VOLB				2.7 V		0.22	0.5	V	
		I <sub>OL</sub> = 24 mA	4.5 V	3 V		0.21	0.44		
	_			4.5 V		0.18	0.44		
t <sub>I</sub>	Control inputs	VI = VCCA or GND	5.5 V	3.6 V		±0.1	±1	μΑ	
''	Control inputs	AL = ACC A OL CIAD	3.5 V	5.5 V		±0.1	±1	μΑ	
loz†	A or B ports	$V_O = V_{CCA/B}$ or GND, $V_I = V_{IL}$ or $V_{IH}$	5.5 V	3.6 V		±0.5	±5	μΑ	
		$A_n = V_{CC}$ or GND	5.5 V	Open		8	80		
ICCA	B to A	A $I_O$ (A port) = 0, $B_D = V_{CCB}$ or GND	5.5 V	3.6 V		8	80	μΑ	
		$I_O$ (A port) = 0, $B_n = V_{CCB}$ or GND	3.5 V	5.5 V		8	80		
loop	A to B	$A_n = V_{CCA}$ or GND, $I_O$ (B port) = 0	5.5 V	3.6 V		5	50	μΑ	
ICCB	AIOB	An = VCCA or GND, IO (B port) = 0	3.5 V	5.5 V		8	80	μΑ	
	A port	$V_L = V_{CCA} - 2.1 \text{ V}$ , Other inputs at $V_{CCA}$ or GND, OE at GND and DIR at $V_{CCA}$	5.5 V	5.5 V		1.35	1.5		
∆I <sub>CCA</sub> ‡	ŌĒ	$V_I = V_{CCA} - 2.1 \text{ V}$ , Other inputs at $V_{CCA}$ or GND, DIR at $V_{CCA}$ or GND	5.5 V	5.5 V		1	1.5	mA	
	DIR	$V_L = V_{CCA} - 2.1 \text{ V}$ , Other inputs at $V_{CCA}$ or GND, OE at $V_{CCA}$ or GND	5.5 V	3.6 V		1	1.5		
∆lccb <sup>‡</sup>	B port	$V_L$ = V <sub>CCB</sub> – 0.6 V, Other inputs at V <sub>CCB</sub> or GND, OE at GND and DIR at GND	5.5 V	3.6 V		0.35	0.5	mA	
Ci	Control inputs	V <sub>I</sub> = V <sub>CCA</sub> or GND	Open	Open		5		pF	
C <sub>io</sub>	A or B ports	VO = VCCA/B or GND	5 V	3.3 V		11		pF	

<sup>†</sup> For I/O ports, the parameter IOZ includes the input leakage current.

<sup>&</sup>lt;sup>‡</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or the associated V<sub>CC</sub>.

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# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figures 1 through 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CCA</sub> = 5 V ± 0.5 V, V <sub>CCB</sub> = 5 V ± 0.5 V		$V_{CCA} = 5 \text{ V}$ $\pm 0.5 \text{ V}$ , $V_{CCB} = 2.7 \text{ V}$ TO 3.6 V		UNIT
			MIN	MAX	MIN	MAX	
<sup>t</sup> PHL	А	В	1	7.1	1	7	ns
t <sub>PLH</sub>	A	В	1	6	1	7	115
<sup>t</sup> PHL	В	А	1	6.8	1	6.2	ns
t <sub>PLH</sub>	Ь	٨	1	6.1	1	5.3	115
t <sub>PZL</sub>		A	1	9	1	9	ns
<sup>t</sup> PZH	ŌĒ	۸	1	8.3	1	8	115
t <sub>PZL</sub>	<u>OE</u>	В	1	8.2	1	10	20
<sup>t</sup> PZH	OE	В	1	8.1	1	10.2	ns
t <sub>PLZ</sub>	<u></u>	А	1	4.7	1	5.2	no
<sup>t</sup> PHZ	ŌĒ	A	1	4.9	1	5.2	ns
t <sub>PLZ</sub>		В	1	5.4	1	5.4	ns
<sup>t</sup> PHZ	ŌĒ		1	6.3	1	7.4	115

## operating characteristics, $V_{CCA} = 5 \text{ V}$ , $V_{CCB} = 3.3 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS		TYP	UNIT	
	Down dissination conscitance nor transcriver	Outputs enabled	C. 0	f = 10 MHz	20	pF
Cpd	Power dissipation capacitance per transceiver	Outputs disabled	$C_L = 0$ ,	1 = 10 WITZ	6.5	рΓ

## power-up considerations†

TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. Take these precautions to guard against such power-up problems.

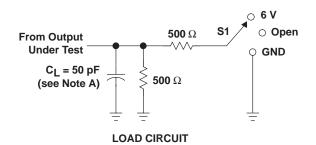
- 1. Connect ground before any supply voltage is applied.
- 2. Next, power up the control side of the device (V<sub>CCA</sub> for all four of these devices).
- 3. Tie  $\overline{\text{OE}}$  to  $V_{CCA}$  with a pullup resistor so that it ramps with  $V_{CCA}$ .
- 4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V<sub>CCA</sub>. Otherwise, keep DIR low.

<sup>†</sup> Refer to the TI application report, Texas Instruments Voltage-Level-Translation Devices, literature number SCEA021.

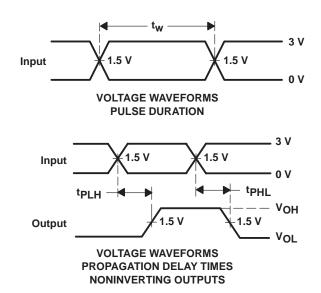


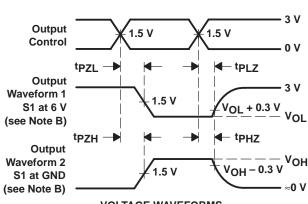
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# PARAMETER MEASUREMENT INFORMATION FOR A TO B $V_{CCA} = 4.5 \text{ V}$ TO 5.5 V AND $V_{CCB} = 2.7 \text{ V}$ TO 3.6 V



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	6 V
tPHZ/tPZH	GND





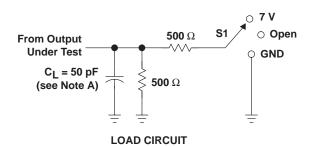
VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns.  $t_f \leq$  2.5 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. All parameters and waveforms are not applicable to all devices.

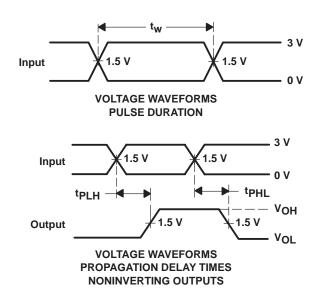
Figure 1. Load Circuit and Voltage Waveforms

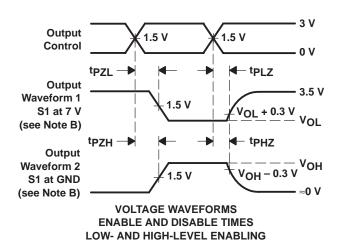


# PARAMETER MEASUREMENT INFORMATION FOR A TO B $V_{CCA} = 4.5 \text{ V}$ TO 5.5 V AND $V_{CCB} = 3.6 \text{ V}$ TO 5.5 V



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	7 V
tPHZ/tPZH	GND





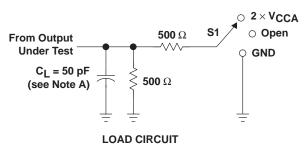
NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns.  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

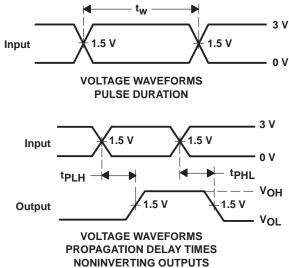
Figure 2. Load Circuit and Voltage Waveforms

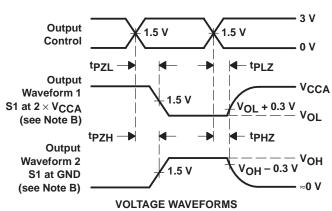
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# PARAMETER MEASUREMENT INFORMATION FOR B TO A $V_{CCA} = 4.5 \text{ V}$ TO 5.5 V AND $V_{CCB} = 2.7 \text{ V}$ TO 3.6 V



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	2×V <sub>CCA</sub>
tPHZ/tPZH	GND





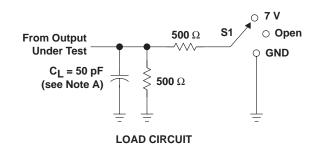
VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns.  $t_f \leq$  2.5 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. All parameters and waveforms are not applicable to all devices.

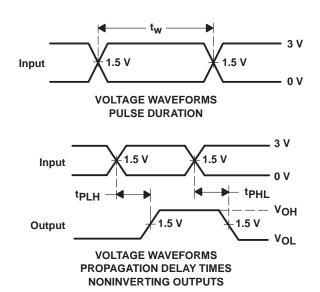
Figure 3. Load Circuit and Voltage Waveforms

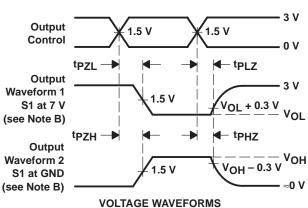


# PARAMETER MEASUREMENT INFORMATION FOR B TO A $V_{CCA} = 4.5 \text{ V}$ TO 5.5 V AND $V_{CCB} = 3.6 \text{ V}$ TO 5.5 V



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	7 V
tPHZ/tPZH	GND





VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

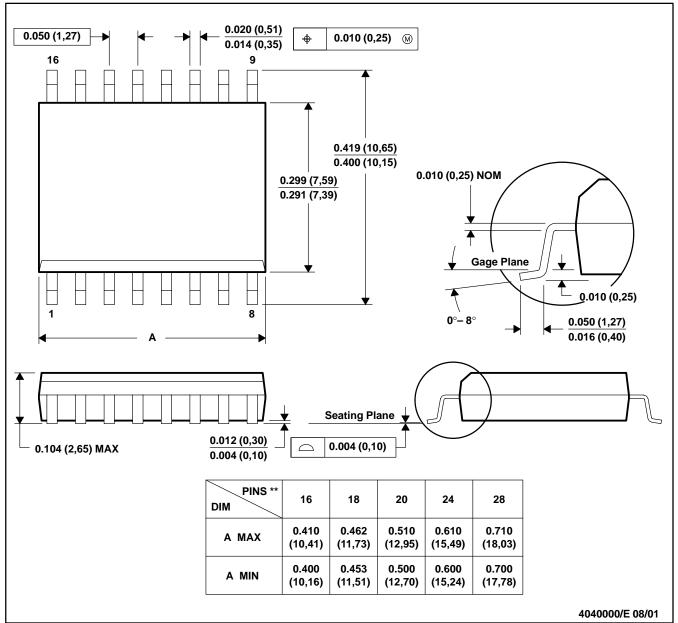
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns.  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms

### DW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **16 PINS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

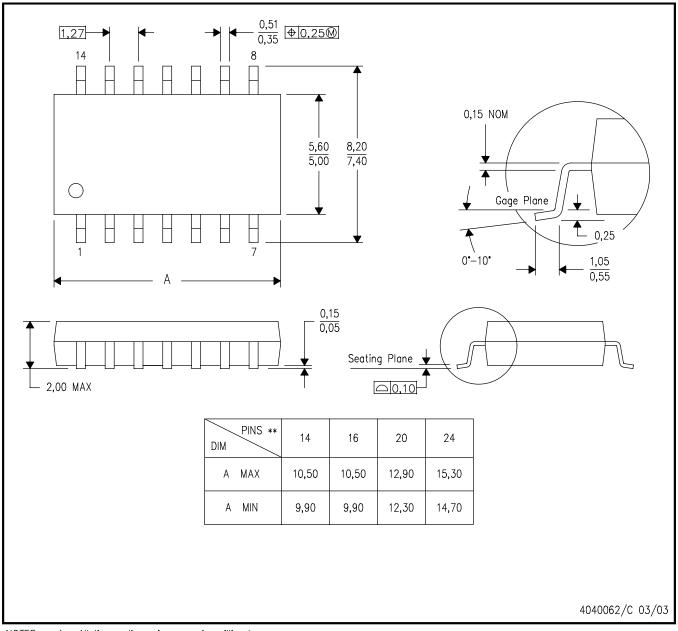
D. Falls within JEDEC MS-013

## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

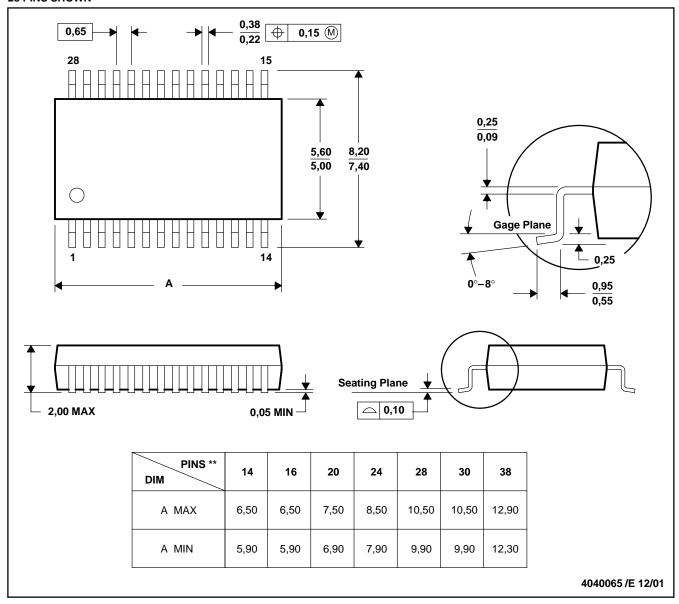
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

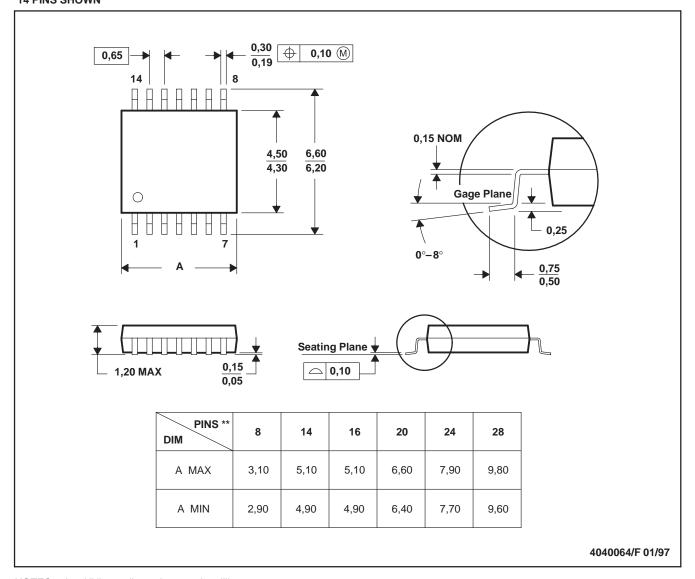
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

### 14 PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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